Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

!\ REMINDERS

Product information in this catalog is as of October 2009. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel").
 It is only applicable to the products purchased from any of TAIYO YUDEN' s official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

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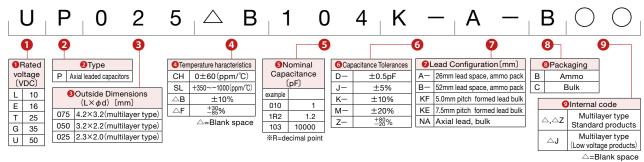
FEATURES

- This widely used ceramic capacitor provides a wide capacitance range of 1pF through 10μ F in one standard size and shape.
- Automatic insertion related costs are lower than with radial type capacitors.
- Mounting pitch can be between 5mm to 26mm which could be used

APPLICATIONS

• The class 1 temperature compensating (NPO) products can be used in circuits to stabilize frequency and temperature characteristics. The B, and F dielectrics are optimum for bypass capacitors.

ORDERING CODE



EXTERNAL DIMENSIONS/Minimum Quantity

TYPE		Dimensions		Taped product	Bulk P	roduct	Minimum Quantity [P		
ITPE	L	φD	φd	Straight	Straight	Formed		Bulk	Taping
Multilayer Type 075	4.2max. (0.165max.)	3.2max. (0.126max.)	0.55±0.05 (0.022±0.002)	B 52mm		Pitch:7.5mm (0,295)	Α	_	2000 (075)
Multilayer Type 050	3.2max.	2.2max.	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	. (2.05)	N A	K F	В	_	3000 (050) 5000 (025)
, ,,	(0.126max.)	(0.87max.)	0.45±0.05 (0.018±0.002)		_		NA	1000	_
Multilayer Type 025	2.3max. (0.09max.)	2.0max. (0.079max.)	(0.016±0.002)	26mm (1.02)		Pitch: (0.197)	KE (075)	3000	_
						Unit : mm(inch)	KF (050)	3000	_
ΔVAII ΔRI E CA	APACITANCE	RANGE					KF (025)	4000	_

A \ / A I	A D I E	-	ITANIOE	DANIOE
AVAII	ARIE	CAPAC	IIANI Æ	RANGE

Class 1 (Tem	perature o	compe	nsating)	Class 2 (Hig	gh dielectri	c const	ant)											M	ultilaye	er type
WV			50V(UP)	WV	,			50V(UP))		3	35V(GP)	25V	(TP)		16V	(EP)		10V(LP)
Temp.ch	har.	С	Н	SL	Temp.o	har.		В		F		E	3	F	В	F		B F		F	
Type ca	ap.	025	050	025	Туре с	ар.	025	050	075	025	050	050	075	075	075	025	025	050	025	050	050
[pF]	[pF:3digits]	025	050	025	[pF]	[pF:3digits]	025	050	0/5	025	050	050	0/5	0/5	0/5	025	025	050	025	050	050
1	010				100	101															
1.2	1R2	_			120	121															
1.5	1R5				150	151															
1.8	1R8			-	180	181															
2.2	2R2			-	220	221	-														
2.7	2R7			-	270	271 331															
3.3	3R3 3R9			-	330 390	391															
3.9 4.7	4R7			-	470	471	-														-
5.6	5R6	-		-	560	561	-														
6.8	6R8			-	680	681	-														-
8.2	8R2	_		-	820	821															-
10	100			-	1000	102	-														-
11	110				1200	122	-														
12	120				1500	152															
13	130				1800	182															
15	150				2200	222															
16	160				2700	272															
18	180				3300	332											_				
20	200				3900	392															
22	220				4700	472															
24	240				5600	562															
27	270				6800	682															
30	300				8200	822															
33	330				10000	103									İ						
36	360				12000	123															
39	390				15000	153															
43	430				18000	183															
47	470				22000	223															
51	510				27000	273															
56	560				33000	333															
62	620				39000	393															
68	680				47000	473															
100	101				56000	563															
150	151				68000	683															
220	221				82000	823															
330	331				100000	104															
470	471				220000	224															ļ
680	681				470000	474															
1000	102			<u> </u>	1000000	105															
					2200000	225															
					4700000	475															
					10000000	106		I									I				

Temperature char.	Capacitance change	Capacitance Tolerance	Q or tanδ	Class
CH	0±60ppm/°C	D(±0.5pF)		
SL	+350~-1000ppm/°C	K(±10%) J(±5%)	eng·Refer to the Part munber	1
△B	±10%	K(±10%), M(±20%)	ong noise to the rair manser	
△F	+30 -85%	Z(⁺⁸⁰ ₋₂₀ %)		2

*Capacitance characteristics measured at 20°C

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Multilayer 025 Type Class 1

Rated Voltage (DC)	Ordering code	EHS (Environmental Hazardous Substances)	Temperature characteristics	Capacitance (pF)	Capacitance tolerance	Q or tan δ	Insulation resistance
	UP025△010D −○ Z	RoHS		1.0			
	UP025△1R2D −○ Z	RoHS		1.2			
	UP025△1R5D −○ Z	RoHS		1.5			
	UP025△1R8D −○ Z	RoHS		1.8			i
	UP025△2R2D−○ Z	RoHS		2.2	±0.5pF		
	UP025△2R7D − ○ Z	RoHS		2.7			
	UP025△3R3D−○ Z	RoHS		3.3			
	UP025△3R9D−○ Z	RoHS		3.9			
	UP025△4R7D − ○ Z	RoHS		4.7		Q≧400+20C	10000MΩmin.
	UP025△5R6K−○ Z	RoHS		5.6		Q=400+20C	
	UP025△6R8K - ○ Z	RoHS	CH SL	6.8	±10%		
U	UP025△8R2K − ○ Z	RoHS		8.2	1		
	UP025△100J −○ Z	RoHS		10	-		
	UP025△120J −○ Z	RoHS		12			
	UP025△150J −○ Z	RoHS		15			
50V	UP025△180J −○ Z	RoHS	-	18			
	UP025△220J −○ Z	RoHS		22			
	UP025△270J −○ Z	RoHS		27			
	UP025△330J −○ Z	RoHS		33			
	UP025△390J −○ Z	RoHS		39			
	UP025△470J −○ Z	RoHS		47			
	UP025△560J −○ Z	RoHS		56	±5%		
	UP025△680J −○ Z	RoHS		68			
	UP025△820J −○ Z	RoHS		82			
	UP025CH101J − ○ Z	RoHS		100	1	Q≧1000	
UP UP	UP025CH151J −○ Z	RoHS		150	1		
	UP025CH221J −○ Z	RoHS		220	1		
	UP025CH331J −○ Z	RoHS	СН	330	1		
	UP025CH471J −○ Z	RoHS		470	1		
	UP025CH681J −○ Z	RoHS		680	1		
	UP025CH102J - C Z	RoHS		1000	1		

 $[\]triangle$ Please specify the temperature characteristics code and \bigcirc lead configuration code.

Multilayer 025 Type Class 2

Rated Voltage (DC)	Ordering code	EHS (Environmental Hazardous Substances)	Temperature characteristics	Capacitance (pF)	Capacitance tolerance	Q or tan δ	Insulation resistance
	UP025 B101K − ○ Z	RoHS		100			
	UP025 B121K − ○ Z	RoHS		120			
	UP025 B151K − ○ Z	RoHS		150			
	UP025 B181K − ○ Z	RoHS		180			
	UP025 B221K − ○ Z	RoHS		220			
	UP025 B271K − ○ Z	RoHS		270			
	UP025 B331K − ○ Z	RoHS		330			
	UP025 B391K − ○ Z	RoHS		390			
	UP025 B471K − ○ Z	RoHS		470			
	UP025 B561K − ○ Z	RoHS		560			
	UP025 B681K − ○ Z	RoHS		680			
	UP025 B821K − ○ Z	RoHS		820		tan δ ≦3.5%	5000M Ω min.
50V	UP025 B102K - ○ Z	RoHS		1000			
300	UP025 B122K − ○ Z	RoHS		1200			
	UP025 B152K − ○ Z	RoHS	В	1500	±10%		
	UP025 B222K − ○ Z	RoHS		2200			
	UP025 B332K-○ Z	RoHS		3300			
	UP025 B472K − ○ Z	RoHS		4700			
	UP025 B682K-○ Z	RoHS		6800			
	UP025 B103K - ○ Z	RoHS		10000			
	UP025 B153K − ○ Z	RoHS		15000			
	UP025 B223K − ○ Z	RoHS		22000			
	UP025 B333K-○ Z	RoHS		33000			
	UP025 B473K − ○ Z	RoHS		47000			
	UP025 B683K-○ Z	RoHS		68000			1000M Ω min.
	UP025 B104K − ○ Z	RoHS		100000		tan δ ≦5.0%	
	EP025 B224K − ○ Z	RoHS		220000			500M Ω min.
16V	EP025 B474K − ○ Z	RoHS		470000			200M Ω min.
	EP025 B105K - ○ Z	RoHS		100000		tan δ ≦7.5%	100MΩmin.
	UP025 F103Z −○ Z	RoHS		10000			
50V	UP025 F223Z −○ Z	RoHS		22000	_	tan δ ≦7.5%	1000M Ω min.
307	UP025 F473Z −○ Z	RoHS		47000	±80	iano ≥1.3%	TOOOIVI 121111/1.
	UP025 F104Z −○ Z	RoHS	F	100000	+80 _% -20		
	EP025 F224Z −○ Z	RoHS		220000		tan δ ≦10.0%	500M Ω min.
16V	EP025 F474Z −○ Z	RoHS		470000	_	tair0 = 10.070	JUUIVI SZITIIITI.
	EP025 F105Z −○ Z	RoHS		100000		tan δ ≦17.5%	250M Ω min.

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PART NUMBERS

Rated Voltage (DC)	Ordering code	EHS (Environmental Hazardous Substances)	Temperature characteristics	Capacitance (pF)	Capacitance tolerance	Q or tan δ	Insulation resistance	
	EP025 B122M −○J	RoHS		1200				
	EP025 B152M −○J	RoHS		1500				
	EP025 B182M − ○ J	RoHS		1800				
	EP025 B222M−○J	RoHS		2200				
	EP025 B272M − ○ J	RoHS		2700				
	EP025 B332M-○J	RoHS	В -	3300	±20%	tan δ ≦3.5%	5000 Μ Ω min.	
	EP025 B392M − ○ J	RoHS		3900				
101/	EP025 B472M −○ J	RoHS		4700				
16V	EP025 B562M − ○ J	RoHS		5600				
	EP025 B682M − ○ J	RoHS		6800				
	EP025 B822M - ○ J	RoHS]	8200				
	EP025 B103M −○ J	RoHS]	10000				
	EP025 B123M −○ J	RoHS]	12000]			
	EP025 B153M −○ J	RoHS]	15000]			
	EP025 B183M −○ J	RoHS]	18000				
	EP025 B223M −○ J	RoHS]	22000				
	TP025 F103Z −○ J	RoHS		10000				
25V	TP025 F223Z -○J	RoHS	F	22000	+80 -20%	tan δ ≦7.5%	1000M Ω min.	
	TP025 F473Z −○ J	RoHS	1	47000	_20			

[△]Please specify the temperature characteristics code and ○ lead configuration code.

Multilayer type Class 1

		EHS					
Rated		(Environmenta	I Temperature	Capacitance	Capacitance		Insulation
Voltage	Ordering code	Hazardous	characteristics	(pF)	tolerance	Q or $\tan \delta$	resistance
(DC)		Substances)					
	UP050CH220J-○ Z	RoHS		22			
*	UP050CH240J- ○ Z	RoHS		24		Q≧400+20C	
	UP050CH270J- ○ Z	RoHS		27			
*	UP050CH300J-○ Z	RoHS		30			1
	UP050CH330J-○ Z	RoHS		33			
*	UP050CH360J-○ Z	RoHS		36			
	UP050CH390J-○ Z	RoHS		39			
*	UP050CH430J-○ Z	RoHS		43			
	UP050CH470J- ○ Z	RoHS		47			
*	UP050CH510J- ○ Z	RoHS		51			
	UP050CH560J-○ Z	RoHS		56			
*	UP050CH620J-○ Z	RoHS		62			
	UP050CH680J-○ Z	RoHS		68			
*	UP050CH750J- ○ Z	RoHS		75			
*	UP050CH820J-○ Z	RoHS		82			
*	UP050CH910J- ○ Z	RoHS		91	1		
	UP050CH101J- ○ Z	RoHS		100	1		
*	UP050CH111J- ○ Z	RoHS		110	1		
*	UP050CH121J- ○ Z	RoHS		120			
*	UP050CH131J- ○ Z	RoHS		130			
50V	UP050CH151J- ○ Z	RoHS	СН	150	±5%		10000MΩmin.
*	UP050CH161J- ○ Z	RoHS		160		0>4000	
*	UP050CH181J- ○ Z	RoHS		180		Q≧1000	
*	UP050CH201J- ○ Z	RoHS		200			
	UP050CH221J- ○ Z	RoHS		220			
*	UP050CH241J- ○ Z	RoHS		240			
*	UP050CH271J- ○ Z	RoHS		270			
*	UP050CH301J- ○ Z	RoHS		300			
	UP050CH331J- ○ Z	RoHS		330			
*	UP050CH361J- ○ Z	RoHS		360			
*	UP050CH391J- ○ Z	RoHS		390			
*	UP050CH431J- ○ Z	RoHS		430			
	UP050CH471J- ○ Z	RoHS		470			
*	UP050CH511J- ○ Z	RoHS		510			
*	UP050CH561J- ○ Z	RoHS		560			
*	UP050CH621J- ○ Z	RoHS		620			
	UP050CH681J- ○ Z	RoHS		680			
*	UP050CH751J- ○ Z	RoHS		750			
*	UP050CH821J- ○ Z	RoHS		820			
*	UP050CH911J- ○ Z	RoHS					
	UP050CH102J- ○ Z	RoHS		1000			

[△]Please specify the temperature characteristics code and ○ lead configuration code.

^{★ :} Option

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Multilayer type Class 2

(DC)	Ordering code	(Environmental Hazardous Substances)	Temperature characteristics	Capacitance (pF)	Capacitance tolerance	Q or tan δ	Insulation resistance	
*	UP050B122K-○Z	RoHS		1200				
^	UP050B152K-OZ	RoHS	1	1500	1			
*	UP050B182K-OZ	RoHS	1	1800	1			
	UP050B222K-OZ	RoHS		2200	1			
*	UP050B272K-○Z	RoHS		2700	1			
	UP050B332K-○Z	RoHS	1	3300	1			
*	UP050B392K-○Z	RoHS	1	3900	1			
	UP050B472K-○Z	RoHS	1 1	4700	1			
*	UP050B562K-OZ	RoHS	1 1	5600	1			
	UP050B682K-OZ	RoHS	1	6800	1	tan δ ≦3.5%	5000M Ω mi	
*	UP050B822K-OZ	RoHS	1	8200	1			
	UP050B103K-OZ	RoHS	1	10000	1			
-a *	UP050B123K-○Z	RoHS	1 1	12000	1			
50V ^	UP050B153K-○Z	RoHS	1 1	15000	1			
*	UP050B183K-OZ	RoHS	1	18000	1			
	UP050B223K-OZ	RoHS	В	22000	±10%			
*	UP050B273K-OZ	RoHS		27000	1			
	UP050B333K-OZ	RoHS	1	33000	†			
*	UP050B393K-OZ	RoHS	1	39000	†			
	UP050B473K-OZ	RoHS	1	47000				
*	UP050B563K-OZ	RoHS	1	56000				
	UP050B683K-OZ	RoHS	1	68000	1	L. 5 (5.00)	1000M Ω min.	
*	UP050B823K-○Z	RoHS	1	82000	1			
	UP050B104K-OZ	RoHS	1	100000	1	tan δ ≦5.0%		
	UP050B224K-OZ	RoHS	1	220000	1		500MΩmir	
	UP050B474K-OZ	RoHS	1	470000		-		200M Ω mir
35V	GP050B105K−○Z	RoHS	1	1000000	1		100M Ω mir	
	EP050B225K-OZ	RoHS	1	2200000	†	tan δ ≦7.5%	50M Ω min	
16V	EP050B475K-OZ	RoHS	1	4700000	1			
	EP050B106K-OZ	RoHS	1	10000000	1	tan δ ≦12.5%	20MΩmin	
	UP050F103Z-OZ	RoHS		10000				
	UP050F223Z-OZ	RoHS	1	22000	1			
	UP050F473Z-OZ	RoHS	1	47000	1	tan δ ≦7.5%	1000M Ω mi	
50V	UP050F104Z-OZ	RoHS	1 1	100000	1			
	UP050F224Z-OZ	RoHS		220000	+80%			
	UP050F474Z-OZ	RoHS	F	470000	-20 [%]	tan δ ≦10.0%	500MΩmir	
	UP050F105Z-OZ	RoHS	1 1	1000000	1		250MΩmir	
16V	EP050F225Z-OZ	RoHS	1 1	2200000	1	tan δ ≦15%	125MΩmir	
	LP050F475Z-OZ	RoHS	1 1	4700000	1		50MΩmin	
10V	LP050F106Z-OZ	RoHS	1 1	10000000	1	tan δ ≦17.5%	25MΩmin	
50V	UP075B105K-O	RoHS		1000000		tan δ ≦5.0%	100MΩmir	
	GP075B225K-O	RoHS	1 _	2200000	1		50MΩmin	
35V	GP075B475K-O	RoHS	В	4700000		tan δ ≦7.5%		
25V	TP075B106K-O	RoHS	1	10000000	1	tan δ ≦12.5%	20MΩmin.	

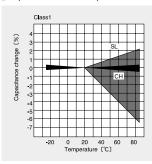
[△]Please specify the temperature characteristics code and ○ lead configuration code.

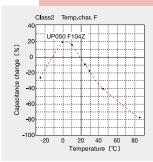
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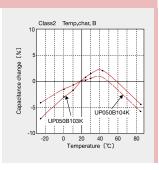
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Capacitance -vs- Temperature Characteristics







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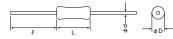
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1)Minimum Quantity

T	l	Minim	um Quantity (PCS)
Type	Lead configuration code	Bulk	Taping
	A-(1.024 inch wide)		2000 (075)
Multilayer	B-(2.047 inches wide)		3000 (050) 5000 (025)
type	NA	1000	
(075, 050, 025)	KE (075)	3000	
	KF (050)	3000	_
	KF (025)	4000	

②Dimensions of Bulk Products

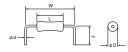
NA configuration



Type		Dimensions(mm)								
туре	φD	L	φd	l						
Multilayer	2.0max	2.3max	0.45±0.05	20.0min.						
type 025	(0.079)	(0.09)	(0.018±0.002)	(0.787)						
Multilayer	2.2max	3.2max	0.45±0.05	20.0min.						
type 050	(0.087)	(0.126)	(0.018±0.002)	(0.787)						
Multilayer	3.2max	4.2max	0.55±0.05	20.0min.						
type 075	(0.126)	(0.165)	(0.022±0.002)	(0.787)						

Unit: mm(inch)

KF/KE configuration

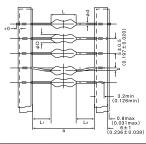


Type	リード形状記号		Din	nensions(m	ım)	
туре	7 11/1/1/10/10/5	φD	L	W	φd	l
Multilayer	KF	2.0max	2.3max	5.0±0.5	0.45±0.05	6.5±0.5
type 025	KF	(0.079max)	(0.09max)	(0.197±0.020)	(0.018±0.002)	(0.256±0.020)
Multilayer	L/E	2.2max	3.2max	5.0±0.5	0.45±0.05	6.5±0.5
type 050	KF	(0.087max)	(0.126max)	(0.197±0.020)	(0.018±0.002)	(0.256±0.020)
Multilayer	VE.	3.2max	4.2max	7.5±0.5	0.55±0.05	6.5±0.5
type 075	KE	(0.126max)	(0.165max)	(0.295±0.020)	(0.022±0.002)	(0.256±0.020)

Unit: mm(inch)

3 Taping Dimensions

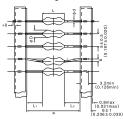
■ A-(a: 1.024 inch wide) configuration



_		Dimensions(mm)					
Type	φD	L	а	b	L ₁ -L ₂	φd	insertion pitch
Multilayer	2.0max	2.3max				0.45±0.05	
type 025	(0.079max)	(0.09max)	+0.5			(0.018±0.002)	5.0
Multilayer	2.2max	3.2max	26 ^{+0.5}	0.8max.	0.5max	0.45±0.05	(0.197)
type 050	(0.087max)	(0.126max)	(1.024+0.020)	(0.031max.)	(0.020max.)	(0.018±0.002)	
Multilayer	3.2max	4.2max	(1.02.1 0)	(GIGG IIIIGAI)		0.55±0.05	7.5
type 075	(0.126max)	(0.165max)				(0.022±0.002)	(0.295)

Unit: mm(inch)

■ B− (a : 2.047 inches wide) configuration



			Dimens	ions(mm)		Minimum
Type	φD	L	а	b	L ₁ -L ₂	φd	insertion pitch
Multilayer	2.0max	2.3max				0.45±0.05	
type 025	(0.079max)	(0.09max)	52 ⁺²			(0.018±0.002)	5.0
Multilayer	2.2max	3.2max	52 -1	1.2max.	1.0max	0.45±0.05	(0.197)
type 050	(0.087max)	(0.126max)	(2,047+0.079)	(0.047max.)	(0.039max.)	(0.018±0.002)	
Multilayer	3.2max	4.2max	(200 11 -0.0039)	(olo ir mani)	(Olocoman)	0.55±0.05	7.5
type 075 (0.126max) (0.165max) (0.022±0.002)							(0.295)
*Radial tap	Radial taping is available for 075 type (Optional)						mm(inch)

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1. Operating Temperature Range	
Multilayer type Contracted	
Specified High Permittivity (Class2)	
Value	
Characteristics : F)	
2. Storage Temperature Compensating (Class 1) Specified Value Temperature Compensating (Class 2) 3. Facted Voltage Temperature Compensating (Class 3) Multilayer type (Characteristics 8) Multilayer type (Cha	
Temperature Compensating (Class 1)	
Specified High Permittivity (Class2)	
Age Parentitivity Class2	
Multilayer type Characteristics Foundation Characteristics Foundation Characteristics Foundation Characteristics Foundation Foun	
Characteristics : F) SovDC	
Temperature Compensating (Class 1) Multilayer type (Characteristics : B) 16VDC. 25VDC. 35VDC. 56VDC	
Temperature Compensating (Class 1) Multilayer type (Characteristics : B) 16VDC. 25VDC. 35VDC. 56VDC	
Multilayer type (Characteristics : B)	
High Permittivity (Class2)	
### Authors and Fernance Multilayer type	
4. Withstanding Voltage Between terminals Specified No abnorminality Value No abnorminality (Tiest Methods and Remarks) Specified No abnorminality Value No abnorminality No abnormin	
Specified No abnorminality	
Specified No abnorminality	
Specified No abnorminality No abnorminality No abnorminality Applied voltage Faited Voltage Stade (Voltage S	
Test Methods and Remarks Applied voltage : Rated VoltageX2 (Class 1)	
Applied voltage : Rated Voltagex2 (Class 1)	
Duration : 1 to 5 sec.	
Duration : 1 to 5 sec. Charge/(Sbarge current : 50mA max. (Class 1,2)	
Specified Value Permittivity (Class2) Permittiv	
Specified No abnominality	
Value	
Tiest Methods and Remarks	
Metal globule method Applied voltage : Rated Voltage×2.5, Duration : 1 to 5 sec., Charge/Discharge current : 50mA max.	
Temperature Compensating (Class1) Multilayer type 10000MΩmin.	
Temperature Compensating (Class1) Multilayer type 10000MΩmin.	
Rated Nottage : 16VDC 1200pF / 22000pF (Item : Δ) : 5000MΩ min 22000pF : 500MΩ min (100000pF : 20MΩ min (100000pF : 20MΩ min (100000pF : 20MΩ min (1000000pF : 20MΩ min (10000000pF : 200000pF : 20MΩ min (100000000pF : 200000pF : 200000pF : 2000000pF : 200000pF : 2000000pF : 2000	
1200pF~22000pF (tem : △) : 5000MΩ min 5000MΩ min 70000pF 5000MΩ min 700000pF 2000MΩ min 1000000pF 5000MΩ min 1000000pF 2500MΩ min 10000000pF 2500MΩ min 100000000pF 2500MΩ min 10000000pF 2500MΩ min 10000000000pF 2500MΩ min 1000000000pF 2500MΩ min 100000000pF 2500MΩ min 10000000pF 2500	
A	
High Permittivity (Class2) High Permittivity (Class2) High Permittivity (Class2) High Permittivity (Class2) Multilayer type (Characteristics : F) Multilayer type (Characteristics : F) High Permittivity (Class2) Multilayer type (Characteristics : F)	
Multilayer type (Characteristics : B)	
Multilayer type (Characteristics : B)	
Muttilayer type (Characteristics : B)	
Multilayer type (Characteristics : B)	
Characteristics : B)	
1000000pF	
Specified Value High Permittivity (Class2) High Permittivity (Class	
Rated Ivoltage : 50VDC 100F~29000pF : 5000MΩ min 47000pF~100000pF : 1000MΩ min 220000pF : 2200MΩ min 470000pF : 2200MΩ min 1000000pF : 1000MΩ min 1000000pF : 500MΩ min 1000000pF : 500MΩ min 1000000pF : 500MΩ min 10000000pF : 500MΩ min 10000000pF : 500MΩ min 10000000pF : 500MΩ min 10000000pF : 25MΩ min 1000000pF : 500MΩ min 1000000pF : 500MΩ min 1000000pF : 500MΩ min 1000000pF : 250MΩ min 1000000pF : 250MΩ min 1000000pF : 125MΩ min 100000pF : 125MΩ min 100000pF : 125MΩ min 100000pF : 25MΩ min 100000pF : 25MΩ min 1000000pF : 25MΩ min 10000000pF : 25MΩ min 1000000pF : 25MΩ min 1000000000pF : 25MΩ min 1000000pF : 25MΩ min 10000000pF : 25MΩ min 1000000pF : 25MΩ min 1000000pF : 25MΩ min 100000	
Specified Value	
Specified Value	
$\begin{array}{c} 470000 \text{pF} & : 200 \text{M}\Omega \text{ min} \\ 1000000 \text{pF} & : 100 \text{M}\Omega \text{ min} \\ \hline \\ Rated \text{ Ivoltage} : 10 \text{VDC} \\ 4700000 \text{pF} & : 50 \text{M}\Omega \text{ min} \\ 470000 \text{pF} & : 50 \text{M}\Omega \text{ min} \\ 1000000 \text{pF} & : 25 \text{M}\Omega \text{ min} \\ 1000000 \text{pF} & : 25 \text{M}\Omega \text{ min} \\ 220000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 220000 \text{pF} & : 250 \text{M}\Omega \text{ min} \\ 220000 \text{pF} & : 125 \text{M}\Omega \text{ min} \\ 220000 \text{pF} & : 125 \text{M}\Omega \text{ min} \\ \hline \\ Rated \text{ voltage} : 25 \text{VDC} \\ 10000 \text{pF} \sim 47000 \text{pF} (\text{Item}\triangle \text{J}) : 1000 \text{M}\Omega \text{ min} \\ \text{Rated voltage} : 35 \text{VDC} \\ 1000000 \text{pF} & : 25 \text{M}\Omega \text{ min} \\ \hline \\ Rated \text{ voltage} : 50 \text{VDC} \\ 10000 \text{pF} \sim 47000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 220000 \text{pF} \sim 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 220000 \text{pF} \sim 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 220000 \text{pF} \sim 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 220000 \text{pF} \sim 470000 \text{pF} & : 500 \text{M}\Omega \text{ min} \\ 1000000 \text{pF} & : 250 \text{M}\Omega \text{ min} \\ 1000000 \text{pF} & : 250 \text{M}\Omega \text{ min} \\ \hline \end{array}$	
1000000pF : 100MΩ min	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
4700000pF :50MΩ min 1000000pF :25MΩ min Rated Ivoltage :16VDC 220000pF :500MΩ min 470000pF :500MΩ min 1000000pF :500MΩ min 1000000pF :250MΩ min 2200000pF :250MΩ min 1000000pF :250MΩ min 1000000pF :125MΩ min Rated voltage :25VDC 10000pF~47000pF(Item△J) :1000MΩ min Rated voltage :35VDC 1000000pF :25MΩ min Rated voltage :50VDC 10000pF~100000pF :500MΩ min 220000pF~470000pF :500MΩ min 1000000pF :250MΩ min 10000000pF :250MΩ min 1000000pF :250MΩ min 1000000pF :250MΩ min 1000000pF :250MΩ min 1000000pF :250MΩ min 10000000pF :250MΩ min 1000000pF :250MΩ min :250MΩ	
Rated Voltage : 16VDC	
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	
$\begin{array}{c} \text{Multilayer type} \\ \text{(Characteristics : F)} \\ \text{(Characteristics : F)} \\ \\ \text{(Analyse)} \\ (A$	
Multilayer type 2200000pF : 125MΩ min Rated voltage : 25VDC 10000pF~47000pF(ltem△J) : 1000MΩ min Rated voltage : 35VDC 1000000pF : 25MΩ min Rated voltage : 50VDC 100000pF~100000pF : 1000MΩ min 220000pF~470000pF : 500MΩ min : 500MΩ min 1000000pF : 25MΩ min : 250MΩ min	
(Characteristics : F) Rated voltage : 25VDC 1000DpF~47000DpF (ttem△J) : 1000MΩ min Rated voltage : 35VDC 1000000pF : 25MΩ min Rated voltage : 50VDC 10000pF~100000pF : 1000MΩ min 220000pF~470000pF : 500MΩ min 100000pF : 250MΩ min	
Rated voltage : 35VDC 10000000pF	
$\frac{10000000 p \tilde{F}}{Rated \ voltage} : 25 M \Omega \ min}$ $Rated \ voltage : 50 V D C$ $10000 p F \sim 100000 p F$ $: 1000 M \Omega \ min}$ $220000 p F \sim 470000 p F$ $: 250 M \Omega \ min}$ $1000000 p F$ $: 250 M \Omega \ min}$	
Rated voltage : 50VDC 1000pF 10000pF 10000pF 220000pF~470000pF : 500MΩ min 100000pF : 250MΩ min 100000pF : 250MΩ min	
220000pF~470000pF : 500MΩ min 1000000pF : 250MΩ min	
1000000pF :250MΩ min	
[Test Methods and Remarks]	
Applied voltage: Rated voltage, Duration: 60±5 sec.	
6. Capacitance	
±0.5pF	
Temperature Compensating (Class1) Multilayer type ±5%	
Specified ±10%	
\(\frac{\lambda}{\lambda}\)\(\text{value}\) \(\text{Multilayer type}\) \(\frac{\partial \text{\partial \	
High Permittivity (Class 2) (Characteristics B)	
Multilayer type (Characteristics : F) +80 ₉ -20	
Test Methods and Remarks	
Measuring frequency ∶1MHz±10% (Class 1 : C≦1000pF) Measuring voltage ∶1.0±0.5Vrms (Class 1 : C≦1000pF) Bias application : None	one
: 1kHz±10% (Class 1 : C>1000pF) : 1.0±0.2Vrms (Class 1 : C>1000pF) : 1kHz±10% (Class 2 : C≦10µF) : 1.0±0.2Vrms (Class 2 : C≦10µF)	
: 120Hz±10% (Class 2: C>10µF) : 1.0±0.2VIII (Class 2: C>10µF) : 120Hz±10% (Class 2: C>10µF)	

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Temperature Compensating (Class 1) Multisyer type		ED CERAMIC CAPACITORS				
Specified Software Compensating (Class 1) Multilayer type	7. Q or Tange	nt of Loss Angle(tanδ)		20pE or under: 0>400+	200	
1200pF - 20000pF 10000pF 1200pF		Temperature Compensating (Class1)	Multilayer type	33pF or over : Q≥1000		
High Permittivity (Class2)				1200pF~22000pF (Item 2 10000pF 220000pF − 470000pF 1000000pF 4700000pF 4700000pF 255 VDC 10000000pF 2200000pF 2200000pF 2200000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 24700000pF 2470000pF 24700000pF 2470000pF 247000pF 247000pF 247000pF 247000pF 247000pF 247000pF 2470000pF 247000pF	: 5.0% max : 5.0% max : 7.5% max : 12.5% max : 12.5% max : 5.0% max : 7.5% max : 3.5% max	
Measuring trequency : IMHz±10% Class 1 : C\$1000pF Measuring voltage : 1,0±0.5Vms Class 1 : C\$1000pF Elias application : None I : 1,0±0.5Vms Class 1 : C\$1000pF Elias application : None I : 1,0±0.5Vms Class 2 : C\$10µF Elias 3 : C\$10µF Elias 2 : C\$10µF Elias 3 : C\$10µF Eli		High Permittivity (Class2)		470000pF~1000000pl Rated Ivoltage : 16VDC 220000pF 470000pF 1000000pF 2200000pF Rated Ivoltage : 25VDC 10000pF~47000pF (Item Rated Ivoltage : 35VDC 1000000pF Rated Ivoltage : 50VDC 1000000pF~100000pF 220000pF~470000pF 220000pF~470000pF	F: 17.5% max : 10.0% max : 10.0% max : 17.5% max : 15.0% max : 15.0% max : 17.5% max : 17.5% max : 17.5% max : 10.0% max	
When voltage is not applied Temperature Compensating (Class1)		equency : 1MHz±10% (Class 1 : C≦10 : 1kHz±10% (Class 1 : C>10 : 1kHz±10% (Class 2 : C≦10	000pF) 0µF)	g voltage :1.0±0.5Vrms (:1.0±0.2Vrms (:1.0±0.2Vrms (Class 1 : C>1000pF) Class 2 : C≦10μF)	Bias application : None
When voltage is not applied Temperature Compensating (Class1) Multilayer type (Characteristics : B) Multil	8 Capacitano					
Iemperature Compensating (Class1) Multilayer type St.: -350~+1000 [ppm/C]	•	· · · · · · · · · · · · · · · · · · ·	- Capacitance Change			
Figure High Permittivity (Class2) Characteristics is Multilayer type High Permittivity (Class2) Class Cl		Temperature Compensating (Class1)			m/°C]	
Test Methods and Remarks Measurement of capacitance at 20°C and 85°C, -25°C shall be made to calculate temperature characteristic by the following equation. (Class 1)		High Permittivity(Class2)	(Characteristics : B) Multilayer type			
9. Terminal Strength Tensile Temperature Compensating (Class1) Multilayer type (Characteristics : B) Multilayer type (Characteristics : F) Test Methods and Remarks] Apply the stated tensile force progressively in the direction to draw terminal. Nominal wire diameter [mm] Tensile force [N] Duratio [s] Temperature Compensating (Class1) Multilayer type (Characteristics : B) Multilayer type (Characteristics : F) Test Methods and Remarks Suspend a mass at the end the terminal, incline the body through angle of 90° and return it to initial position. This operation is done over a period of 5 sec. Then second bend in the opposite direction shall be made. Nominal wire diameter [mm] Bending force [N] Mass weight [kg]	$\frac{(C_{85} - C_{20})}{C_{20} \times \triangle T}$ Change of material Temperature	t of capacitance at 20°C and 85°C, -25°C	shall be made to calculat o 5 (Class 2) step 4 : 85°C step 5 : 20°C	e temperature characteristic	by the following equation.	(Class 1)
Temperature Compensating (Class1) Multilayer type Multilayer type (Characteristics : B) Multilayer type (Characteristics : F) Test Methods and Remarks Apply the stated tensile force progressively in the direction to draw terminal. Nominal wire diameter [mm] Tensile force [N] Duratio [s]	9. Terminal St					
Test Methods and Remarks Apply the stated tensile force progressively in the direction to draw terminal. Nominal wire diameter [mm] Tensile force [N] Duratio [s]	Specified		Multilayer type (Characteristics : B)	No abnomalities, such as	cuts or looseness of termin	nals.
Temperature Compensating (Class1) Multilayer type			(Characteristics: F)			
Temperature Compensating (Class 1) Multilayer type	Torsional		-			
Test Methods and Remarks] Suspend a mass at the end the terminal, incline the body through angle of 90° and return it to initial position. This operation is done over a period of 5 sec. Then second bend in the opposite direction shall be made. Number of bends: 2 times Nominal wire diameter [mm] Bending force [N] Mass weight [kg]	Specified		Multilayer type (Characteristics : B) Multilayer type	No abnomalities, such as	cuts or looseness of termin	nals.
Nominal wire diameter [mm] Bending force [N] Mass weight [kg]	Suspend a m This operation	ass at the end the terminal, incline the boon is done over a period of 5 sec. Then sec	dy through angle of 90° ar			

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10. Resistance	e to Vibration			
			Appearance : No significant a	
			Withstanding Voltage : No ab	
			Capacitance:	
				±0.5pF
	Temperature	Multilayer type	5.6pF~8.2pF : Within	
	Compensating (Class1)	Wattayer type	10pF or over : Within	
			Q:30pF or under : Q≥40	
			33pF or over : Q≧10	
			Insulation resistance : 10000 C : Nominal Capacitance : [pF	
			Appearance : No significant	
			Withstanding Voltage: No at Rated Voltage: 16VDC	onomality
			Capacitance: Within ±10%	
			1200pF~22000pF(Item△J)	: Within ±20%
			220000pF~10000000pF	: Within ±10%
			tanδ:	
			1200pF~22000pF(Item△J)	
			220000pF~470000pF	: 5.0% max
			1000000pF~2200000pF	: 7.5% max
			4700000pF~10000000pF	: 12.5% max
			Insulation Resistance: 1200pF~22000pF(Item△J)	: 5000MΩ min
			220000pF	: 500MΩ min
			470000pF	: 200MΩ min
			100000pF	: 100MΩ min
			2200000pF	: 50MΩ min
			4700000pF~1000000pF	20MΩ min
			Rated Voltage : 25VDC	
			Capacitance: Within ±10%	
			tanδ:	
		Multilayer type (Characteristics : B)	1000000pF	: 12.5% max
		Widitiayer type (Griarasteristics - B)	Insulation Resistance:	
			1000000pF	: 20MΩ min
			Rated Voltage : 35VDC	
			Capacitance : Within ±10% tanδ :	
			1000000pF	: 5.0% max
			2200000pF~4700000pF	7.5% max
Specified			Insulation Resistance:	17.570 max
Value			100000pF	: 100MΩ min
			2200000pF	: 50MΩ min
			4700000pF	: 20MΩ min
			Rated Voltage : 50VDC	
	High Permittivity (Class2)		Capacitance: Within ±10%	
	,, (2.2.2.2,		tanδ:	
			100pF~39000pF	: 3.5% max
			47000pF~1000000pF	: 5.0% max
			Insulation Resistance:	
			100pF~39000pF	: 5000MΩ min
			47000pF~100000pF	: 1000MΩ min
			220000pF	: 500MΩ min
			470000pF	: 200MΩ min
			100000pF	: 100MΩ min
			Appearance : No significant	abnomality
			Withstanding Voltage: No at	
			Rated Voltage: 10VDC	
			Capacitance: Within +80 %	
			20 %	
			tanδ:	
	1	1	4700000pF~10000000pF	: 17.5% max
			Handalah Danistanan 1	
			Insulation Resistance:	. 50110
			4700000pF	: 50MΩ min
			4700000pF 10000000pF	: 50M Ω min : 25M Ω min
			4700000pF 10000000pF Rated Voltage : 16VDC	
		Multilayer type (Characteristics : F)	4700000pF 10000000pF	
		Multilayer type (Characteristics : F)	4700000pF 10000000pF Rated Voltage : 16VDC Capacitance : Within +80 %	
		Multilayer type (Characteristics : F)	470000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tanδ :	: 25MΩ min
		Multilayer type (Characteristics : F)	470000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tanδ : 220000pF	: 25MΩ min : 10.0% max
		Multilayer type (Characteristics : F)	470000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tanā : 220000pF 470000pF	: 25MΩ min : 10.0% max : 10.0% max
		Multilayer type (Characteristics : F)	4700000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tan 5 : 220000pF 470000pF 1000000pF	: 25MΩ min : 10.0% max : 10.0% max : 17.5% max
		Multilayer type (Characteristics : F)	470000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tanā : 220000pF 470000pF	: 25MΩ min : 10.0% max : 10.0% max
		Multilayer type (Characteristics : F)	4700000pF 1000000pF Rated Voltage : 16VDC Capacitance : Within +80 % tan 5 : 220000pF 470000pF 1000000pF	: 25MΩ min : 10.0% max : 10.0% max : 17.5% max
		Multilayer type (Characteristics : F)	470000pF 1000000pF 10000000pF Rated Voltage : 16VDC Capacitance : Within + 80 % tan δ : 220000pF 470000pF 100000pF 220000pF Insulation Resistance : 220000pF 120000pF 1200000pF 12000000pF 1200000pF 1200000000000000000000000000000000000	: 25MΩ min : 10.0% max : 10.0% max : 17.5% max
		Multilayer type (Characteristics : F)	470000pF 1000000pF Rated Voltage: 16VDC Capacitance: Within +80 % tanδ: 220000pF 470000pF 1000000pF 220000pF lnsulation Resistance: 220000pF 470000pF	: 25MΩ min : 10.0% max : 10.0% max : 17.5% max : 15.0% max
		Multilayer type (Characteristics : F)	470000pF 1000000pF 10000000pF Rated Voltage : 16VDC Capacitance : Within + 80 % tan δ : 220000pF 470000pF 100000pF 220000pF Insulation Resistance : 220000pF 120000pF 1200000pF 12000000pF 1200000pF 1200000000000000000000000000000000000	: 25MΩ min : 10.0% max : 10.0% max : 17.5% max : 15.0% max

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10. Resistanc	e to Vibration			
			Rated Voltage : 25VDC Capacitance : Within +80 %	
			tanδ: 10000pF~47000pF(Item△J) Insulation Resistance: 10000pF~47000pF(Item△J)	
			Rated Voltage : 35VDC Capacitance : Within +80 %	1000112 11111
Specified Value	High Permittivity (Class2)	Multilayer type (Characteristics : F)	tanδ: 10000000pF Insulation Resistance: 10000000pF	: 17.5% max : 25ΜΩ min
			Rated Voltage : 50VDC Capacitance : Within +80 %	*LOTING TIME
	and Danadal		tanδ: 10000pF~100000pF 220000pF~470000pF 1000000pF Insulation Resistance:	: 7.5% max : 10.0% max : 15.0% max
			10000pF~100000pF 220000pF~470000pF 1000000pF	: 1000M Ω min : 500M Ω min : 250M Ω min

[Test Methods and Remarks]
According to JIS C 5102 clause 8.2
Vibration type: A
Directions: 2 hrs each in X, Y and Z directions
Total: 6 hrs
Frequency range: 10 to 55 to 10Hz (1min)
Amplitude: 1.5 mm
Mounting method: Soldering onto the PC board

			Appearance: No significant abnomality
	Temperature	Multilayer type	Withstanding Voltage: No abnomality Capacitance: 4.7pF or under : Within ±0.5pF 5.6pF~8.2pF : Within ±10% 10pF or over : Within ±5%
	Compensating (Class1)		Q : 30pF or under Q≥400+20C : 33pF or over Q≥1000 Insulation resistance : 10000MΩ min.
			C : Nominal Capacitance[pF] Appearance : No significant abnomality Withstanding Voltage : No abnomality
			Rated Voltage : 16VDC Capacitance : 1200pF~22000pF(Item△J) : Within ±20% 220000pF~10000000pF : Within ±10%
Specified Value		Multilayer type (Characteristics : B)	tanδ: 1200pF~22000pF(Item△J): 3.5% max 220000pF~470000pF :5.0% max 1000000pF~2200000pF :7.5% max 4700000pF~10000000pF :12.5% max
			Insulation resistance : 1200pF~22000pF(tem \triangle J) : 5000M Ω min 220000pF : 500M Ω min 470000pF : 200M Ω min 1000000pF : 100M Ω min 2200000pF : 50M Ω min 4700000pF : 200M Ω min 4700000pF~10000000pF : 200M Ω min
	High Permittivity (Class2)		Rated Voltage: 25VDC Capacitance: Within ±10% tanδ: 1000000pF :12.5% max Insulation resistance: 1000000pF :20MΩ min
			Rated Voltage : 35VDC Capacitance : Within ±10% tanô : 1000000pF : 5.0% max 22000000pF~4700000pF : 7.5% max
			Insulation resistance :
			Rated Voltage: 50VDC Capacitance: Within±10% tanδ: 100pF~39000pF 3.5% max 47000pF~1000000pF 5.0% max
			47000PF 100000PF 15.0% Max 100PF 100PF 1000MΩ min 100000PF 100MΩ min 1000000PF 100MΩ min 100000PF 1

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11. Free Fall	LB OLITAVIIO OAI AOTI		
TI. Tiee Fall			Appearance : No significant abnomality Withstanding Voltage : No abnomality Rated Voltage : 10VDC Capacitance : Within +80 %
			tan δ : 470000pF \sim 1000000pF : 17.5% max Insulation resistance : 470000pF : 50M Ω min 1000000pF : 25M Ω min Rated Voltage : 16VDC Capacitance : Within $^{+80}_{-20}$ %
			tanδ: 220000pF : 10.0% max 470000pF : 10.0% max 100000pF : 17.5% max 220000pF : 15.0% max Insulation resistance: 22000pF : 500MΩ min 47000pF : 500MΩ min 1000000pF : 250MΩ min 220000pF : 125MΩ min 220000pF : 125MΩ min
Specified Value	High Permittivity (Class2)	Multilayer type (Characteristics : F)	Rated Voltage: 25VDC Capacitance: Within +80 %
			tanδ: 10000pF~47000pF(Item△J) : 7.5% max Insulation resistance: 10000pF~47000pF(Item△J): 1000MΩ min
			Rated Voltage: 35VDC Capacitance: Within +80 %
			tanδ: 1000000pF :17.5% max Insulation resistance: 1000000pF :25MΩ min
			Rated Voltage : 50VDC Capacitance : Within $^{+80}_{-20}$ %
			tanō: 10000pF~10000pF : 7.5% max 22000pF~47000pF : 10.0% max 100000pF : 15.0% max Insulation resistance:
Tast Mathada	and Remarks		10000pF~100000pF : 1000MΩ min 220000pF~470000pF : 500MΩ min 1000000pF : 250MΩ min

Drop Test : Free fall Impact material : Floor Height : 1 m

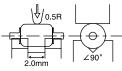
Total number of drops : 5 times

12. Body Strength

Specified	Temperature Compensating(Class1)	Multilayer type	
	High Permittivity (Class2)	Multilayer type (Characteristics : B)	No abnomality such as damage.
		Multilayer type (Characteristics : F)	

Test Methods and Remarks Applied force: 19.6N

Duration: 5 sec.
Speed: Shall attain to specified force in 2 sec.



1.5mm (025type)

13. Solderability						
Temperature Specified Compensating(Class1)		Multilayer type				
Value	High Permittivity (Class2)	Multilayer type (Characteristics : R)	At least 75% of lead surface is covered with new solder.			
	night Fermittivity (Glassz)	Multilayer type (Characteristics : F)				

[Test Methods and Remarks]
Solder temperature: 230±5°C
Duration: 2±0.5 sec. (This test may be applicable after 6 months storage.)

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14. Soldering			Appearance : No significant abnomality
			Withstanding Voltage: No abnomality
	Temperature Compensating (Class1)	Multilayer type	Capacitance change: 8.2pF or under : Within ±0.25pF 10pF or over : Within ±2.5% Q:30pF or under Q≥400+20C : 33pF or over Q≥1000 Insulation resistance: 10000MΩ min.
			C : Nominal Capacitance[pF]
		Multilayer type (Characteristics : B)	Appearance : No significant abnomality Withstanding Voltage : No abnomality Rated Voltage : 16VDC Capacitance change : 1200pF~22000pF (Item△J) : Within ±7.5% 220000pF~10000000pF : Within ±10.0% tanδ : 1200pF~22000pF (Item△J) : 3.5% max 220000pF~470000pF : 5.0% max 100000pF~2200000pF : 7.5% max 470000pF~10000000pF : 12.5% max Insulation resistance : 1200pF~22000pF (Item△J) : 5000MΩ min 470000pF : 500MΩ min 470000pF : 200MΩ min 100000pF : 500MΩ min 470000pF : 500MΩ min 470000pF~10000000pF : 500MΩ min 470000pF~10000000pF : 20MΩ min 470000pF~10000000pF : 20MΩ min 470000pF~10000000pF : 20MΩ min 470000pF~10000000pF : 20MΩ min Rated Voltage : 25VDC Capacitance change : 10000000pF : 12.5% max Insulation resistance : 10000000pF : 20MΩ min Rated Voltage : 35VDC
Specified Value	High Permittivity (Class2)		Capacitance change: 1000000pF~4700000pF : Within ±10.0% tanδ: 1000000pF~4700000pF : 7.5% max 2200000pF~4700000pF : 7.5% max Insulation resistance: 1000000pF : 100MΩ min 220000pF : 50MΩ min 470000pF : 20MΩ min Rated Voltage: 50VDC Capacitance change: 100pF~39000pF : Within ±7.5% 47000pF~1000000pF : Within ±10.0% tanδ: 100pF~39000pF : 3.5% max 47000pF~1000000pF : 5.0% max Insulation resistance: 100pF~39000pF : 500MΩ min 47000pF~100000pF : 500MΩ min 47000pF~100000pF : 1000MΩ min 47000pF : 200MΩ min 470000pF : 200MΩ min 470000pF : 100MΩ min 470000pF : 100MΩ min
		Multilayer type (Characteristics : F)	Appearance : No significant abnomality Withstanding Voltage : No abnomality Rated Voltage : 10VDC Capacitance change : Within ±20% tanδ : 470000pF ~1000000pF : 17.5% max Insulation resistance : 470000pF : 25MΩ min 1000000pF : 25MΩ min Rated Voltage : 16VDC Capacitance change : Within ±20% tanδ : 220000pF ~47000pF : 10.0% max 100000pF : 17.5% max Insulation resistance : 220000pF ~47000pF : 500MΩ min 100000pF : 250MΩ min 220000pF : 250MΩ min 220000pF : 125MΩ min 220000pF : 125MΩ min 220000pF : 125MΩ min 220000pF : 250MΩ min 220000pF : 250MΩ min 220000pF : 47000pF (tem△J) : 7.5% max Insulation resistance sitance change : Within ±20% tanδ : 10000pF ~47000pF (tem△J) : 7.5% max Insulation resistance :

Withstanding voltage is also referred to as "voltage proof" under IEC specifications. Thermal Shock is also referred to as "rapid change of temperature" under IEC specifications.

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14. Soldering				
Specified Value	High Permittivity(Class2)	Multilayer type (Characteristics : F)	Insulation resistance: 1000000pF Rated Voltage: 50VDC Capacitance change: 10000pF~100000pF tano: 10000pF~100000pF 220000pF~470000pF	Within ±20% : 17.5% max : 25MΩ min : Within ±20.0% : 7.5% max : 10.0% max : 15.0% max : 10.00MΩ min

Test Methods and Remarks Solder temperature: 270±5°C Duration: 5±0.5 sec.

Preconditions: Inserted into the PC board (with t=1.6mm, hole=1.0mm diameter)

Preconditioning: 1 hr of preconditioning at 150 + 0 followed by 48±4 hrs of recovery under the standard condition.

Recovery: Recovery for the following period under the standard condition after the test.

24±2 hrs (Class 1) 48±4 hrs (Class 2)

15. Resistance	15. Resistance to Solvent					
Specified	Temperature Compensating(Class1)	Multilayer type				
Value	High Permittivity (Class2)	Multilayer type (Characteristics : B)	No significant abnormality in appearance and legible marking.			
		Multilayer type (Characteristics : F)				

[Test Methods and Remarks] According to JIS C 5102 clause 8.7.4. Type of test: Method 1 Solvent temperature : 20 to 25°C Duration : 30±5 sec.

Solvent Type : A in Table 23, Isopropyl alcohol

16. Thermal S	hock		
			Appearance : No significant abnomality Withstanding Voltage : No abnomality
	Temperature Compensating(Class1)	Multilayer type	Capacitance change : 8.2pF or under : Within ±0.5pF 10pF or over : Within ±5.0% Q : 8.2pF or under Q≥200+10C : 10pF~30pF Q≥275+2.5C : 33pF or over Q≥350 Insulation resistance : 1000MΩ or over C : Nominal Capacitance[pF]
Specified Value	High Permittivity(Class2)	Multilayer type (Characteristics : B)	Appearance : No significant abnomality
			2200000pF : 25MΩ min 4700000pF : 5MΩ min

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16. Thermal SI	hock			
			Rated Voltage: 50VDC Capacitance change: 100pF~39000pF 47000pF~1000000pF	: Within ±12.5% : Within ±15.0%
		Multilayer type (Characteristics : B)	tan <i>ō</i> : 100pF∼39000pF 47000pF∼1000000pF	: 5.0% max : 7.5% max
			Insulation resistance : 100pF~39000pF 47000pF~100000pF 220000pF 470000pF 1000000pF	: 1000MΩ min : 500MΩ min : 250MΩ min : 100MΩ min : 50MΩ min
			Appearance : No significant a Withstanding Voltage : No abo	bnomality
			Rated Voltage : 10VDC Capacitance change	: Within ±30.0%
			tanδ : 4700000pF∼10000000pF : 20	0.0% max
			Insulation resistance : 4700000pF 10000000pF	: 10MΩ min : 5MΩ min
			Rated Voltage: 16VDC Capacitance change	: Within ±30.0%
Specified Value	High Permittivity (Class2)	Multilayer type (Characteristics : F)	tanō: 220000pF∼470000pF 1000000pF 2200000pF	: 15.0% max : 22.5% max : 17.5% max
			Insulation resistance : 220000pF 470000pF 1000000pF 2200000pF	: 100MΩ min : 50MΩ min : 25MΩ min : 25MΩ min
			Rated Voltage : 25VDC Capacitance change	: Within ±30%
			tanδ: 10000pF~47000pF(Item△J) Insulation resistance: 10000pF~47000pF(Item△J)	
			Rated Voltage : 35VDC Capacitance change	: Within ±30.0%
			tanδ: 10000000pF Insulation resistance:	: 20.0% max
			10000000pF Rated Voltage : 50VDC Capacitance change : 10000pF~1000000pF	: 5MΩ min : Within ±30.0%
			tanδ: 10000pF~100000pF 220000pF~470000pF 1000000pF	: 12.5% max : 15.0% max : 17.5% max
			Insulation resistance : 10000pF~100000pF 220000pF~470000pF 1000000pF	: 500MΩ min : 250MΩ min : 50MΩ min

[Test Methods and Remarks] Conditions for 1 cycle

Step	Temperature [°C]	Duration [min.]
1	Room temperature	Within 3
2	$-25\pm^{0}_{3}$	30±3
3	Room temperature	Within 3
4	$+85\pm_{0}^{3}$	30±3
5	Room temperature	Within 3

Number of cycles: 5

Preconditioning: 1 hr of preconditioning at 150 $_{-10}^{+0}$ °C followed by 48±4 hrs of recovery under the standard condition. Recovery: Recovery for the following period under the standard condition after the removal from test chamber. 24±2 prs (Class 1)

48±4 hrs (Class 2)

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17. Damp Hea	t (steady state)		
	Temperature Compensating(Class1)	Multilayer type	Appearance : No significant abnomality Withstanding Voltage : No abnomality Capacitance change : 8.2pF or under : Within ±0.5pF 10pF or over : Within ±5.0% 0 : 8.2pF or under
Specified Value	High Permittivity(Class2)	Multilayer type (Characteristics : B)	Appearance : No significant abnormality
		Multilayer type (Characteristics : F)	Appearance : No significant abnomality

With standing voltage is also referred to as "voltage proof" under IEC specifications.

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17. Damp Hea	7. Damp Heat (steady state)				
			Rated Voltage:25VDC Capacitance change	: Within ±30%	
			tanδ: 10000pF~47000pF(Item/ Insulation resistance: 10000pF~47000pF(Item/		
	High Permittivity (Class2)	Multilayer type (Characteristics : F)	Rated Voltage : 35VDC Capacitance change tanδ:	: Within ±30.0%	
Consideral			10000000pF	: 20.0% max	
Specified Value			Insulation resistance: 10000000pF	÷5MΩ min	
			Rated Voltage:50VDC Capacitance change: 10000pF~1000000pF tanð:	: Within ±30.0%	
			10000pF~100000pF 220000pF~470000pF	: 12.5% max : 15.0% max	
			1000000pF	: 17.5% max	
			Insulation resistance: 10000pF~100000pF	: 500MΩ min	
			220000pF~470000pF 1000000pF	: 250MΩ min : 50MΩ min	

	s and Remarks]			
Temperature: Humidity: 90	to 95 % RH			
Duration: 500	hrs ⁺²⁴ ₋₀ hrs	1450 ⁺⁰ °O (allowed by 40 4 by		4 199
Recovery: 24:	±2 hrs of recovery under th	at 150^{+0}_{-10} °C followed by 48 ± 4 hrs of e standard condition after the remove	al from test chamber. (Class	1)
:1 h	r of preconditioning at 150	$^{+10}_{-0}$ °C followed by 48 \pm 4 hrs of recov	very under the standard cond	ition after the removal from chamber. (Class 2)
19 Loading II	nder Damp Heat			
16. Loading u	nder bamp neat		Appearance : No significant	t abnomality
	Temperature	Multilayer type	Withstanding Voltage: No a Capacitance change: 8.2pF or under : Within: 10pF or over : Within:	abnomality ±0.75pF
	Compensating (Class1)	Wulliayer type	Q:30pF or under Q≧100- :33pF or over Q≧200 Insulation resistance:500M	+10/3°C 4Ω min
			C : Nominal Capacitance[p	
			Appearance : No significant Withstanding Voltage : No a	
			Rated Voltage: 16VDC Capacitance change: 1200pF~22000pF(Item△J 220000pF~470000pF 1000000pF~10000000pF) : Within ±12.5% : Within ±15.0%
	High Permittivity (Class2)	Multilayer type (Characteristics : B)	tanō: 1200pF~22000pF(Item△J 220000pF~470000pF 100000pF~2200000pF 4700000pF~1000000pF	: 7.5% max : 10.0% max
			Insulation resistance: 1200pF~22000pF(Item△J 220000pF 470000pF	
			1000000pF 2200000pF 4700000pF~10000000pF	: 12.5M Ω min : 5.0M Ω min
Specified Value			Rated Voltage : 25VDC Capacitance change : 10000000pF tanδ :	: Within ±22.5%
			10000000pF Insulation resistance : 10000000pF	: 22.5% max : 2.5MΩ min
			Rated Voltage : 35VDC Capacitance change :	
			100000pF	: Within ±15.0%
			2200000pF 4700000pF	: Within ±15.0% : Within ±22.5%
			tanδ:	
			1000000pF 2200000pF~4700000pF	: 10.0% max : 10.0% max
			Insulation resistance:	. 10.070 max
			1000000pF	: 12.5MΩ min
			2200000pF 4700000pF	: 5.0MΩ min : 2.5MΩ min
			Rated Voltage : 50VDC	
			Capacitance change:	MERCA 140 FOV
			100pF~39000pF 47000pF~1000000p tanδ∶	: Within ±12.5% : Within ±15.0%
			100pF~39000pF 47000pF~1000000pF Insulation resistance:	: 5.0% max : 7.5% max
			100pF~39000pF 47000pF~100000pF 220000pF	: 500MΩ min : 250MΩ min : 125MΩ min
			470000pF 1000000pF	: 12.5MΩ min : 12.5MΩ min
	1	1		

With standing voltage is also referred to as "voltage proof" under IEC specifications.

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Loading u	under Damp Heat			
			Appearance : No significan Withstanding Voltage : No	
			Rated Voltage: 10VDC Capacitance change tano:	: Within ±30.0%
			4700000pF~10000000pF Insulation resistance : 4700000pF	. 20.0% max : 5MΩ min
			1000000pF	: 3MΩ min
			Rated Voltage: 16VDC Capacitance change tanŏ:	: Within ±30.0%
			220000pF~470000pF	: 15.0% max
			1000000pF	: 22.5% max
			2200000pF	: 17.5% max
			Insulation resistance:	
			220000pF	: 50MΩ min
			470000pF	: 25MΩ min
			1000000pF	: 12.5MΩ min
			2200000pF	: 12.5MΩ min
ecified	Link Dameitti it. (Classo)	M. Hile	Rated Voltage : 25VDC	.11/// 1 00 00/
alue	High Permittivity (Class2)	Multilayer type (Characteristics : F)	Capacitance change	: Within ±30.0%
			tanδ: 10000pF~47000pF(Item/	\ \\:10 E0/ may
			Insulation resistance:	△J) · 12.5% IIIdX
			10000pF~47000pF(Item/	\.I): 250MO min
			Rated Voltage: 35VDC	-0) · 2001412 min
			Capacitance change:	Within ±30.0%
			tanδ:	Within ±30.070
			1000000pF	: 20.0% max
			Insulation resistance:	
			1000000pF	: 2.5MΩ min
			Rated Voltage : 50VDC	
			Capacitance change : 10000pF~100000pF tanδ :	: Within ±30.0%
			10000pF~100000pF	: 12.5% max
			220000pF~470000pF	: 15.0% max
			1000000pF	: 17.5% max
			Insulation resistance:	
			10000pF~100000pF	: 250MΩ min
			220000pF~470000pF	: 125MΩ min
			1000000pF	: 25MΩ min

Test Methods and Remarks]
Temperature: 40±2°C
Humidity: 90 to 95 % RH
Duration: 500 $^{+0.0}_{-0.0}$ hrs
Applied voltage: Rated voltage
Preconditioning: 1 hr of preconditioning at 150 $^{+0.0}_{-10}$ °C followed by 48±4 hrs of recovery under the standard condition.
Recovery: 24±2 hrs of recovery under the standard condition after the removal from test cham-ber. (Class 1):
1 hr of preconditioning at 150 $^{+0.0}_{-10}$ °C followed by 48±4 hrs of recovery under the standard condition after the removal from test cham-ber. (Class 2)

19. High Temp	perature Lading Test		
	Temperature Compensating (Class1)	Multilayer type	Appearance : No significant abnomality Withstanding Voltage : No abnomality Capacitance change : 8.2pF or under : Within ±0.3pF 10pF or over : Within ±3.0% Q : 8.2pF or under Q≧200+10C : 10pF~30pF Q≥275+2.5C : 33pF or over Q≥350 Insulation resistance : 1000MΩ min C : Nominal Capacitance[pF]
Specified Value	High Permittivity (Class2)	Multilayer type (Characteristics : B)	Appearance : No significant abnomality

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	perature Lading Test			
			Rated Voltage : 25VDC	
			Capacitance change:	
			1000000pF	: Within ±22.5%
			tanδ:	········· ··/-
			1000000pF	: 22.5% max
			Insulation resistance: 10000000pF	÷5MΩ min
			Rated Voltage : 35VDC	· 3/1/12 11/111
			Capacitance change:	
			1000000pF	: Within ±15.0%
			2200000pF	: Within ±15.0%
			4700000pF tanδ:	: Within ±22.5%
			1000000pF	: 10.0% max
			2200000pF~4700000pF	: 10.0% max
		Multilayer type (Characteristics : B)	Insulation resistance : 1000000pF	: 25MΩ min
			2200000pF	: 25MΩ min
			4700000pF	: $5M\Omega$ min
			Rated Voltage: 50VDC	
			Capacitance change: 100pF~39000pF	: W/ishin ±12.50/
			47000pF~1000000pF	: Within ±12.5% : Within ±15.0%
			tanδ:	
			100pF~39000pF	5.0% max
			47000pF~1000000pF Insulation resistance:	:7.5% max
			100pF~39000pF	: 1000MΩ min
			47000pF~100000pF	: 500MΩ min
			220000pF 470000pF	: 250MΩ min : 100MΩ min
			100000pF	: 100MΩ min
			Appearance : No significant	
			Withstanding Voltage : No a	abnomality
			Rated Voltage: 10VDC	
Specified	High Permittivity (Class2)		Capacitance change tanδ:	: Within ±30.0%
/alue			4700000pF~10000000pF	: 20.0% max
			Insulation resistance:	
			4700000pF 10000000pF	: 10M Ω min : 5M Ω min
			Rated Voltage: 16VDC	· JIVIZZ ITIIIT
			Capacitance change	: ±30%
			tanδ:	
			220000pF~470000pF 1000000pF	: 15.0% max : 22.5% max
			2200000pF	: 17.5% max
			Insulation resistance:	
			220000pF	: 100MΩ min
			470000 F	
			470000pF	: 50MΩ min
			470000pF 1000000pF 2200000pF	
			1000000pF 2200000pF Rated Voltage : 25VDC	: $50M\Omega$ min : $25M\Omega$ min
		Multilayer type (Characteristics : F)	1000000pF 2200000pF Rated Voltage : 25VDC Capacitance change :	: $50M\Omega$ min : $25M\Omega$ min
		Multilayer type (Characteristics : F)	1000000pF 220000pF Rated Voltage : 25VDC Capacitance change : tanδ :	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30%
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage : 25VDC Capacitance change : tanŏ : 10000pF~47000pF(Item△	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30%
		Multilayer type (Characteristics : F)	1000000pF 220000pF Rated Voltage : 25VDC Capacitance change : tanδ :	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max
		Multilayer type (Characteristics : F)	1000000pF 2200000pF Rated Voltage: 25VDC Capacitance change: tanō: 10000pF~47000pF (Item△ Insulation resistance: 10000pF~47000pF (Item△ Rated Voltage: 35VDC	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% .J): 10.0% max .J): 500MΩ min
		Multilayer type (Characteristics : F)	100000pF 2200000pF Rated Voltage: 25VDC Capacitance change: tanŏ: 10000pF~47000pF (Item△ Insulation resistance: 10000pF~47000pF (Item△ Rated Voltage: 35VDC Capacitance change	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max
		Multilayer type (Characteristics : F)	1000000pF 2200000pF Rated Voltage: 25VDC Capacitance change: tanō: 10000pF~47000pF (Item△ Insulation resistance: 10000pF~47000pF (Item△ Rated Voltage: 35VDC	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% .J): 10.0% max .J): 500MΩ min
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanδ: 10000pF~47000pF (Item△ Insulation resistance: 10000pF~47000pF (Item△ Rated Voltage: 35VDC Capacitance change tanδ: 1000000pF Insulation resistance:	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% -J): 10.0% max -J): 500MΩ min : Within ±30.0% : 20.0% max
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanδ: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanδ: 10000000pF Insulation resistance: 10000000pF	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max J): 500MΩ min : Within ±30.0%
		Multilayer type (Characteristics : F)	1000000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanō: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanō: 10000000pF Insulation resistance: 10000000pF Rated Voltage: 50VDC	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% -J): 10.0% max -J): 500MΩ min : Within ±30.0% : 20.0% max
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage : 25VDC Capacitance change : tan	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max J): 500MΩ min : Within ±30.0% : 20.0% max : 5MΩ min
		Multilayer type (Characteristics : F)	1000000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanō: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanō: 10000000pF Insulation resistance: 10000000pF Rated Voltage: 50VDC	: 50MΩ min : 25MΩ min : 25MΩ min Within ±30% -J): 10.0% max -J): 500MΩ min : Within ±30.0% : 20.0% max
		Multilayer type (Characteristics : F)	100000pF 220000pF 220000pF Rated Voltage : 25VDC Capacitance change : tan	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max J): 500MΩ min : Within ±30.0% : 20.0% max : 5MΩ min : Within 30.0% : 10.0% max
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanδ: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanδ: 1000000pF Insulation resistance: 1000000pF Rated Voltage: 50VDC Capacitance change: 10000pF~100000pF tanδ: 10000pF~100000pF tanδ: 10000pF~100000pF 220000pF~470000pF	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max Within ±30.0% : 20.0% max : 5MΩ min : Within 30.0% : 10.0% max : 12.5% max
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanδ: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanδ: 10000000pF Insulation resistance: 10000000pF Rated Voltage: 50VDC Capacitance change: 1000000pF~100000pF tanδ: 10000pF~100000pF tanδ: 10000pF~100000pF 220000pF~470000pF	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max J): 500MΩ min : Within ±30.0% : 20.0% max : 5MΩ min : Within 30.0% : 10.0% max
		Multilayer type (Characteristics : F)	100000pF 220000pF Rated Voltage: 25VDC Capacitance change: tanδ: 10000pF~47000pF(Item△ Insulation resistance: 10000pF~47000pF(Item△ Rated Voltage: 35VDC Capacitance change tanδ: 1000000pF Insulation resistance: 1000000pF Rated Voltage: 50VDC Capacitance change: 10000pF~100000pF tanδ: 10000pF~100000pF tanδ: 10000pF~100000pF 220000pF~470000pF	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max Within ±30.0% : 20.0% max : 5MΩ min : Within 30.0% : 10.0% max : 12.5% max
		Multilayer type (Characteristics : F)	100000pF 220000pF 220000pF Rated Voltage : 25VDC Capacitance change : tan δ : 10000pF~47000pF (Item△ Insulation resistance : 100000pF~47000pF (Item△ Rated Voltage : 35VDC Capacitance change 10000000pF Insulation resistance : 1000000pF Rated Voltage : 50VDC Capacitance change : 10000pF~100000pF 10000pF~100000pF 100000pF~100000pF 1000000pF 100000pF 1000000pF 100000pF 1000000pF 100000pF 1000000pF 100000pF 1000000pF	: 50MΩ min : 25MΩ min : 25MΩ min : 25MΩ min Within ±30% J): 10.0% max J): 500MΩ min : Within ±30.0% : 20.0% max : 5MΩ min : Within 30.0% : 10.0% max : 12.5% max : 17.5% max

[Test Methods and Remarks] Temperature : $85\pm\frac{3}{0}$ °C Duration : $1000\pm\frac{48}{0}$ hrs Applied voltage : Rated voltage×2 : Rated voltage×1.5

: Hated voltage×1.5
Class 2: B 1000000pF(025Type)
B 220000pF~10000000pF(050Type, 075Type)

Preconditioning: 1 hr of preconditioning at 150 + 0° C followed by 48±4 hrs of recovery under the standard condition.

Recovery: 24±2hrs of recovery under the standard condition after the removal from test chamber. (Class1)
:1 hr of preconditioning at 150 + 0° C followed by 48±4 hrs of recovery under the standard condition after the removal from chamber. (Class 2)

Note on standard condition: "standard condition" referred to herein is defined as follows: 5 to 35°C of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure. When there are questions concerning measurement results: In order to provide correlation data, the test shall be conducted under condition of 20±2°C of temperature, 60 to 70% relative humidity,

and 86 to 106kPa of air pressure.Unless otherwise specified, all the tests are conducted under the "standard condition." Withstanding voltage is also referred to as "voltage proof" under IEC specifications.

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1. Circuit Design

♦ Verification of operating environment, electrical rating and performance

1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications. As such, any capacitors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

◆Verification of Rated voltage (DC rated voltage)

The operating voltage for capacitors must always be lower than their rated values.

If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages should be lower than the rated value of the capacitor chosen. For a circuit where both an AC and a pulse voltage may be present, the sum of their peak voltages should also be lower than the capacitor's rated voltage Self-generated heat (Verification of Temperature)

Precautions

1. If the capacitors specified only for DC use are used in AC or pulse circuits, the AC or a pulse current can generate heat inside the capacitor so the self-generated temperature rise should be limited to within 20°C. The surface temperature measured should include this self-temperature rise. Therefore, it is required to limit capacitor surface temperature including self-generated heat should not exceed the maximum operating temperature of +85°C.

Operating Environment precautions
 Capacitors should not be used in the following environments:

(1) Environmental conditions to avoid

- a, exposure to water or salt water.
- b. exposure to moisture or condensation.
- c. exposure to corrosive gases (such as hydrogen sulfide, sulfurous acid, chlorine, and ammonia)

1-1. When an AC or a pulse voltage is applied to capacitors specified for DC use, even if the voltage is less than the rated voltage, the AC current or pulse current running through the capacitor will cause the capacitor to self-generate heat because of the loss characteristics.

The amount of heat generated depends on the dielectric materials used, capacitance, applied voltage, frequency, voltage waveform, etc. The surface

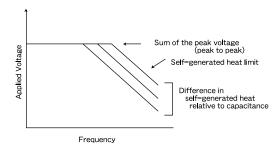
temperature changes due to emitted heat which differs by capacitor shape or mounting method.

Please contact Taiyo Yuden with any questions regarding emitted heat levels in your particular application. It is recommended the temperature rise be

measured in the actual circuit to be used.

1-2. For capacitors, the voltage and frequency relationship is generally determined by peak voltage at low frequencies, and by self-generated heat at high frequencies. (Refer to the following curve.)

Technical considerations



2. PCB Design

Precautions

Design of the capacitor mount

1. When capacitors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not it will cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs. As a result, humidity resistance performance would be lost and may lead to a reduction in insulation resistance and cause a withstand voltage failure.

3. Considerations for automatic insertion

◆Adjustment Automatic Insertion machines (leaded components)

1. When inserting capacitors in a PC board by auto-insertion machines the impact load imposed on the capacitors should be minimized to prevent the leads from chucking or clinching.

Technical conside ations

Precautions

- When installing products, care should be taken not to apply distortion stress as it may deform the products.
- 2. Our company recommends the method to place the lead with fewer loads that join the product.

Soldering 4.

◆Selection of Flux

- 1. When soldering capacitors are on the board, flux should be applied thinly and evenly.
- Flux used should be with less than or equal to 0.1 wt% (equivalent to Chroline) of halogenated content. Flux having a strong acidity content should not be applied. When using water-soluble flux, special care should be taken to properly clean the boards.

Precautions

Technical

Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions.

2. Do not immerse the entire capacitor in the flux during the soldering operation. Only solder the lead wires on the bottom of the board.

Recommended conditions for using a soldering iron:

1. Put the soldering iron on the land-pattern

Soldering iron's temperature - below 350°C Duration - 3 seconds or less

Numbers of times - 1 times

The soldering iron should not directly touch the capacitor.

◆Selection of Flux

1. Flux is used to increase solderability in wave soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.

2. With too much halogenated substance (Chlorine, etc.) content is used to activate the flux, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the capacitors.

3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of capacitors in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

considerations

- ◆Wave Soldering

 1.If capacitors are used beyond the range of the recommended conditions, heat stresses may cause cracks inside the capacitors, and consequently degrade the reliability of the capacitors.
- 2. When the capacitors are dipped in solder, some soldered parts of the capacitor may melt due to solder heat and cause short-circuits or cracking of the ceramic material. Deterioration of the resin coating may lower insulation resistance and cause a reduction of withstand voltage.

◆Recommended conditions for using a soldering iron:

1.lf products are used beyond the range of the recommended conditions, heat stress may deform the products, and consequently degrade the reliability of the products.

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PRECAUTIONS

ations

5. Cleaning ◆Board cleaning 1. When cleaning the mounted PC boards, make sure that cleaning conditions are consistent with prescribed usage conditions. The resin material used for the outer coating of capacitors is occasionally a wax substance for moisture resistance which can easily be dissolved by some solutions. Technical So before cleaning, special care should be taken to test the component's vulnerability to the solutions used. consider When using water-soluble flux please clean the PCB with purified water sufficiently and dry thoroughly at the end of the process. Insufficient washing or drying could lower the reliability of the capacitors. 6. Post-cleaning-process ◆Application of resin molding, etc. to the PCB and components. 1. Please contact your local Taiyo Yuden sales office before performing resin coating or molding on mounted capacitors. Please verify on the actual application that Precautions the coating process will not adversely affect the component quality. The thermal expansion and coefficient of contraction of the molded resin are not necessarily matched with those of the capacitor. The capacitors may be exposed to stresses due to thermal expansion and contraction during and after hardening. This may lower the specified characteristics and insulation resistance or cause Technical reduced withstanding voltage by cracking the ceramic or separating the coated resin from the ceramics With some types of mold resins, the resin's decomposition gas or reaction gas may remain inside the resin during the hardening period or while left under normal ations conditions, causing a deterioration of the capacitor's performance. 1-3. Some mold resins may have poor moisture proofing properties. Please verify the contents of the resins before they are applied. 1-4. Please contact Taiyo Yuden before using if the hardening process temperature of the mold resins is higher than the operating temperature of the capacitors 7. Handling Mechanical considerations Precautions 1. Be careful not to subject the capacitors to excessive mechanical shocks. Withstanding voltage failure may result. 2. If ceramic capacitors are dropped onto the floor or a hard surface they should not be used Technical Because the capacitor is made of ceramic, mechanical shocks applied to the board may damage or crack the capacitors consider 2. Ceramic capacitors which are dropped onto the floor or a hard surface may develop defects and have a higher risk of failure over time 8. Storage conditions ◆Storage 1.To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions: Ambient temperature Below 40 °C Humidity Below 70% RH. Products should be used within 6 months after delivery. After the above period, the solderability should be checked before using the capacitors. Precautions 2. Capacitors should not be kept in an environment filled with decomposition gases such as sulfurous hydrogen, sulfurous acid, chlorine, ammonia, etc 3. Capacitors should not be kept in a location where they may be exposed to moisture, condensation or direct sunlight. Technical Under high temperature/high humidity conditions, the decrease in solderability due to the oxidation of terminal electrodes and deterioration of taping and packaging consider characteristics may be accelerated.

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